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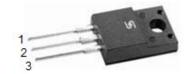




Dual Common Cathode Schottky Rectifier

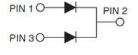
FEATURES

- Low power loss, high efficiency
- Guardring for overvoltage protection
- High surge current capability
- UL Recognized File # E-326243
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition





ITO-220AB





MECHANICAL DATA

Case: ITO-220AB

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - halogen-free Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 1A whisker test

with prefix "H" on packing code meet JESD 201 class 2 whisker test

Polarity: As marked

Mounting torque: 5 in-lbs maximum **Weight:** 1.7 g (approximately)

		MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	MBRF	
PARAMETER	SYMBOL	3035	3045	3050	3060	3090			30200	UNIT
		СТ	СТ	СТ	СТ	СТ	СТ	СТ	СТ	
Maximum repetitive peak reverse voltage	V_{RRM}	35	45	50	60	90	100	150	200	V
Maximum RMS voltage	V_{RMS}	24	31	35	42	63	70	105	140	V
Maximum DC blocking voltage	V_{DC}	35	45	50	60	90	100	150	200	V
Maximum average forward rectified current	I _{F(AV)}		•	•	3	0	•	•		Α
Peak repetitive forward current (Rated VR, Square wave, 20KHz)	I _{FRM}	30						Α		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	700			Α						
Peak repetitive reverse surge current (Note 1)	I _{RRM}	RRM 1 0.5				Α				
Maximum instantaneous forward voltage (Note 2)										
I _F =15A, T _J =25℃		0.	0.70		75 0.		84	0.95	95	
I _F =15A, T _J =125℃	V_{F}	0.	60	0.	65	0.	70	0.	80	V
I _F =30A, T _J =25°C		0.	82	0.	90	0.	94	1.	05	
I _F =30A, T _J =125°ℂ		0.	73	0.	78	0.	82	0.	92	
Maximum reverse current @ rated VR T_J =25 $^{\circ}$ C		0.2							A	
T _J =125 ℃	I _R	2	:0	15		10			mA	
Voltage rate of change (Rated V _R)	dV/dt	10000			V/µs					
Typical thermal resistance	$R_{ heta JC}$	4			°C/W					
Operating junction temperature range	TJ	- 55 to +150							οС	
Storage temperature range	T _{STG}	- 55 to +150					οС			

Note 1: $tp = 2.0 \mu s$, 1.0KHz

Note 2: Pulse test with PW=300µs, 1% duty cycle



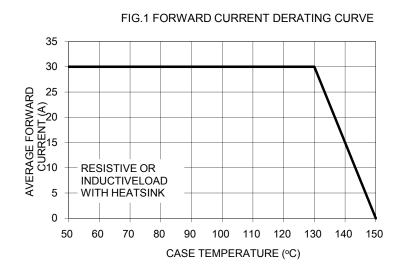
ORDERING INFORMATION						
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING	
	QUALIFIED		CODE			
MBRF30xxCT (Note 1)	Prefix "H"	C0	Suffix "G"	ITO-220AB	50 / Tube	

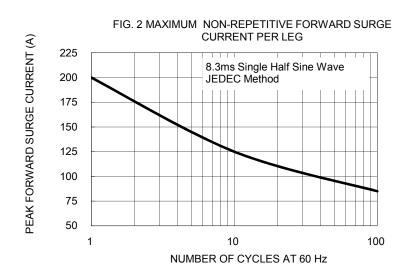
Note 1: "xx" defines voltage from 35V (MBRF3035CT) to 200V (MBRF30200CT)

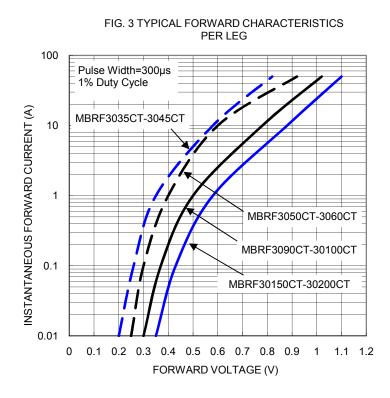
EXAMPLE							
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION		
MBRF3060CT C0	MBRF3060CT		C0				
MBRF3060CT C0G	MBRF3060CT		C0	G	Green compound		
MBRF3060CTHC0	MBRF3060CT	Н	C0		AEC-Q101 qualified		

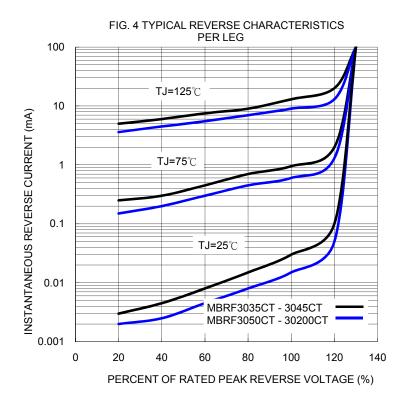
RATINGS AND CHARACTERISTICS CURVES

(TA=25°C unless otherwise noted)



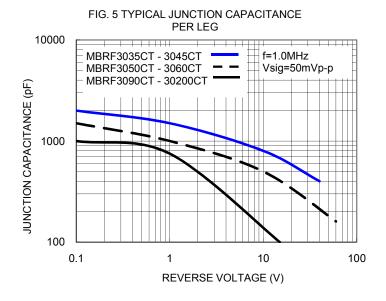


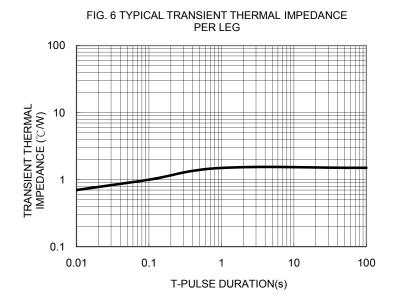




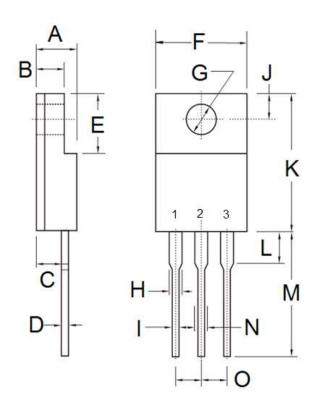








PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	4.30	4.70	0.169	0.185	
В	2.50	3.16	0.098	0.124	
С	2.30	2.96	0.091	0.117	
D	0.46	0.76	0.018	0.030	
Е	6.30	6.90	0.248	0.272	
F	9.60	10.30	0.378	0.406	
G	3.00	3.40	0.118	0.134	
Н	0.95	1.45	0.037	0.057	
I	0.50	0.90	0.020	0.035	
J	2.40	3.20	0.094	0.126	
K	14.80	15.50	0.583	0.610	
L	-	4.10	-	0.161	
М	12.60	13.80	0.496	0.543	
N	-	1.80	-	0.071	
0	2.41	2.67	0.095	0.105	

MARKING DIAGRAM



P/N = Specific Device Code
G = Green Compound

YWW = Date Code F = Factory Code

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Taiwan Semiconductor

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